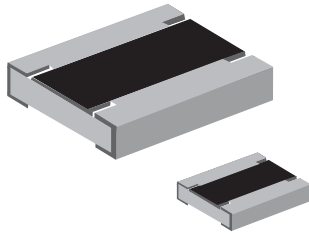


Long Side Termination Thick Film Chip Resistors



FEATURES

- Enhanced power rating
- Long side terminations
- Pure tin solder contacts on Ni barrier layer, provides compatibility with lead (Pb)-free and lead containing soldering processes
- Compliant to RoHS Directive 2002/95/EC
- Halogen-free according to IEC 61249-2-21 definition
- AEC-Q200 qualified



RoHS
COMPLIANT
HALOGEN
FREE

STANDARD ELECTRICAL SPECIFICATIONS

MODEL	SIZE		RATED DISSIPATION P_{70} W	LIMITING ELEMENT VOLTAGE $U_{max. AC/DC}$ V	TEMPERATURE COEFFICIENT ppm/K	TOLERANCE %	RESISTANCE RANGE Ω	SERIES
	INCH	METRIC						
RCL0612 e3	0612	RR 1632M	0.5	75	± 100	± 1	1R0 to 1M	E24; E96
					± 200	± 5		E24
RCL1218 e3	1218	RR 3246M	1.0	200	± 100	± 1	1R0 to 2.2M	E24; E96
					± 200	± 5		E24
RCL1225 e3	1225	RR 3263M	2.0 ⁽¹⁾	200	± 100	± 1	1R0 to 1M	E24; E96
					± 200	± 5		E24

Notes

- These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.
 - Marking: See datasheet "Surface Mount Resistor Marking" (document number 20020).
 - Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material.
- ⁽¹⁾ Specified power rating requires dedicated mounting conditions to achieve the required thermal resistance.

TECHNICAL SPECIFICATIONS

DESCRIPTION	UNIT	RCL0612	RCL1218	RCL1225
Rated Dissipation P_{70} ⁽²⁾	W	0.5	1.0	2.0 ⁽³⁾
Limiting Element Voltage $U_{max. AC/DC}$	V	75	200	200
Insulation Voltage U_{ins} (1 min)	V	> 100	> 300	> 300
Insulation Resistance	Ω	> 10^9		
Category Temperature Range	$^{\circ}\text{C}$	- 55 to + 155		
Weight	mg	11	29.5	55

Notes

- ⁽²⁾ The power dissipation on the resistors generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 $^{\circ}\text{C}$ is not exceeded.
- ⁽³⁾ Specified power rating requires dedicated mounting conditions to achieve the required thermal resistance.

PART NUMBER AND PRODUCT DESCRIPTION

PART NUMBER: RCL061210K0FKEA

R C L 0 6 1 2 1 0 K 0 F K E A 0 0

MODEL/SIZE	RESISTANCE	TOLERANCE	TCR	PACKAGING	SPECIAL
RCL0612 RCL1218 RCL1225	R = Decimal K = Thousand M = Million 0000 = Jumper	F = $\pm 1\%$ J = $\pm 5\%$ Z = Jumper	K = ± 100 ppm/K N = ± 200 ppm/K 0 = Jumper	EA EB EC EK EG	Up to 2 digits 00 = Standard

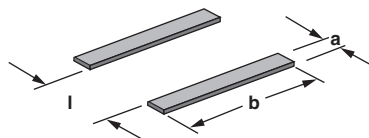
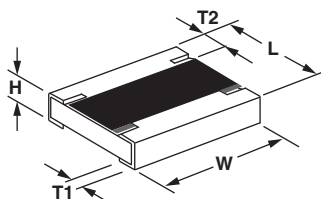
PRODUCT DESCRIPTION: RCL0612 100 10K 1% ET1 e3

RCL0612	100	10K	1%	ET1	e3
MODEL RCL0612 RCL1218 RCL1225	TCR ± 100 ppm/K ± 200 ppm/K	RESISTANCE 10R = 10 Ω 10K = 10 k Ω 1M = 1 M Ω 0R0 = Jumper	TOLERANCE $\pm 1\%$ $\pm 5\%$	PACKAGING ET1 ET5 ET6 ET9 E67	LEAD (Pb)-FREE e3 = Pure tin termination finish

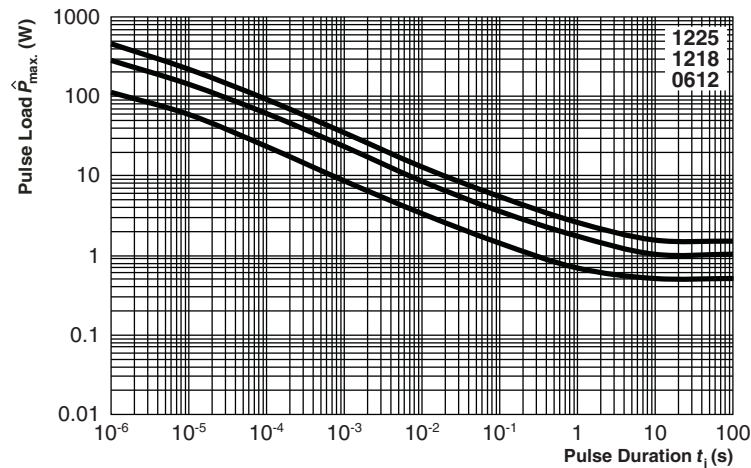
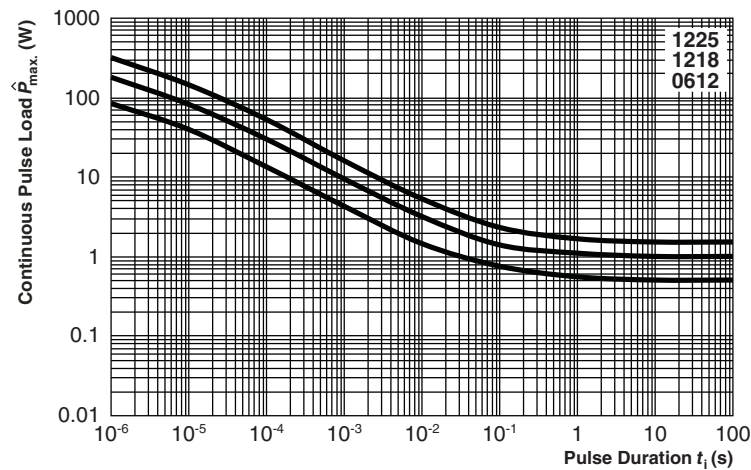
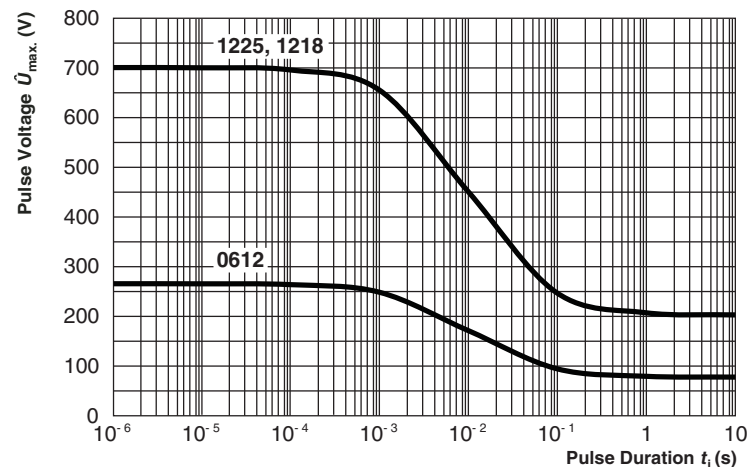
PACKAGING

MODEL	UNIT	PAPER TAPE ON REEL ACC. TO IEC 60286-3, TYPE I			BLISTER TAPE ON REEL ACC. TO IEC 60286-3, TYPE II		
		QUANTITY	PART NUMBER	PRODUCT DESC.	QUANTITY	PART NUMBER	PRODUCT DESC.
RCL0612	180 mm/7"	5000	EA	ET1			
	285 mm/11.25"	10 000	EB	ET5			
	330 mm/13"	20 000	EC	ET6			
RCL1218	180 mm/7"				4000	EK	ET9
RCL1225	180 mm/7"				2000	EG	E67

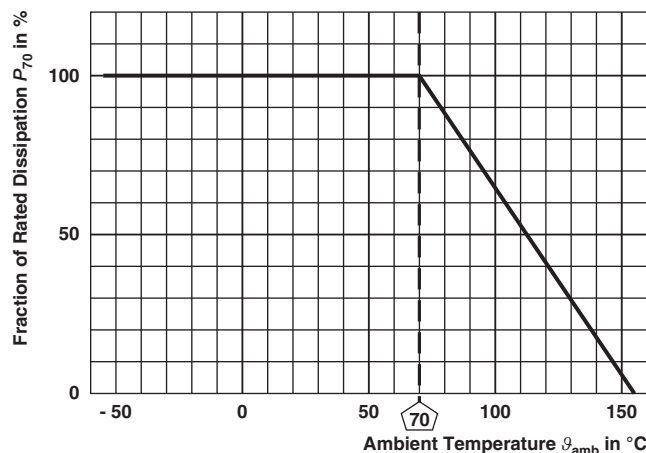
DIMENSIONS in millimeters



SIZE		DIMENSIONS					SOLDER PAD DIMENSIONS					
							REFLOW SOLDERING			WAVE SOLDERING		
INCH	METRIC	L	W	H	T1	T2	a	b	l	a	b	l
0612	1632	1.6 $\pm$ 0.2	3.2 $\pm$ 0.2	0.55 $\pm$ 0.1	0.35 $\pm$ 0.15	0.25 $\pm$ 0.15	0.6	3.2	1.0	1.1	3.2	1.0
1218	3246	3.2 $^{+0.10}_{-0.20}$	4.6 $\pm$ 0.15	0.55 $\pm$ 0.05	0.45 $\pm$ 0.2	0.4 $\pm$ 0.2	1.1	4.9	1.9	1.25	4.8	1.9
1225	3263	3.2 $\pm$ 0.2	6.3 $\pm$ 0.2	0.75 $\pm$ 0.15	0.8 $\pm$ 0.2	0.4 $\pm$ 0.2	1.9	7.6	1.2	1.9	7.6	1.2

FUNCTIONAL PERFORMANCE
Single Pulse

Continuous Pulse

Pulse Voltage


Derating



TEST PROCEDURES AND REQUIREMENTS

EN 60115-1 CLAUSE		IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)	
					STABILITY CLASS 2 OR BETTER	
			Stability for product types:			
			RCL e3	1 Ω to 2.2 M Ω		
4.5	-	Resistance	-	$\pm 1 \%$	$\pm 5 \%$	
4.7	-	Voltage proof	$U = 1.4 \times U_{\text{ins}}$; 60 s	No flashover or breakdown		
4.13	-	Short time overload	$U = 2.5 \times \sqrt{P_{70} \times R}$ $\leq 2 \times U_{\text{max}}$; Duration acc. to style	$\pm (0.25 \% R + 0.05 \Omega)$	$\pm (0.5 \% R + 0.05 \Omega)$	
4.17.2	58 (Td)	Solderability	Solder bath method; Sn60Pb40 non activated flux; (235 $\pm$ 5) $^{\circ}\text{C}$ (2 $\pm$ 0.2) s	Good tinning ($\geq 95 \%$ covered); no visible damage		
			Solder bath method; Sn96.5Ag3Cu0.5 non-activated flux; (245 $\pm$ 5) $^{\circ}\text{C}$ (3 $\pm$ 0.3) s	Good tinning ($\geq 95 \%$ covered); no visible damage		
4.8.4.2	-	Temperature coefficient	(20/- 55/20) $^{\circ}\text{C}$ and (20/125/20) $^{\circ}\text{C}$	$\pm 100 \text{ ppm/K}$	$\pm 200 \text{ ppm/K}$	
4.32	21 (Uu ₃)	Shear (adhesion)	45N	No visible damage		
4.33	21 (Uu ₁)	Substrate bending	Depth 2 mm; 3 times	No visible damage, no open circuit in bent position $\pm (0.25 \% R + 0.05 \Omega)$		
4.19	14 (Na)	Rapid change of temperature	30 min at - 55 $^{\circ}\text{C}$; 30 min at 125 $^{\circ}\text{C}$			
			5 cycles	$\pm (0.25 \% R + 0.05 \Omega)$	$\pm (0.5 \% R + 0.05 \Omega)$	
			1000 cycles	$\pm (1 \% R + 0.05 \Omega)$	$\pm (1 \% R + 0.05 \Omega)$	

TEST PROCEDURES AND REQUIREMENTS					
EN 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)	
				STABILITY CLASS 2 OR BETTER	
			Stability for product types:	1 Ω to 2.2 M Ω	
			RCL e3		
4.23 4.23.2 4.23.3 4.23.4 4.23.5 4.23.6 4.23.7	- 2 (Ba) 30 (Db) 1 (Aa) 13 (M) 30 (Db) -	Climatic sequence: Dry heat Damp heat, cyclic Cold Low air pressure Damp heat, cyclic DC load	- 125 °C; 16 h 55 °C; ≥ 90 % RH; 24 h; 1 cycle - 55 °C; 2 h 1 kPa; (25 $\pm$ 10) °C; 1 h 55 °C; ≥ 90 % RH; 24 h; 5 cycles $U = \sqrt{P_{70}} \times R$	$\pm (1 \% R + 0.05 \Omega)$	$\pm (2 \% R + 0.1 \Omega)$
4.25.1	-	Endurance at 70 °C	$U = \sqrt{P_{70}} \times R \leq U_{\max.}$; 1.5 h on; 0.5 h off; 70 °C; 1000 h 70 °C; 8000 h	$\pm (0.5 \% R + 0.05 \Omega)$ $\pm (1 \% R + 0.05 \Omega)$	$\pm (2 \% R + 0.1 \Omega)$ $\pm (4 \% R + 0.1 \Omega)$
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method (260 $\pm$ 5) °C; (10 $\pm$ 1) s	$\pm (0.25 \% R + 0.05 \Omega)$	$\pm (0.5 \% R + 0.05 \Omega)$
4.35	-	Flamability, needle flame test	IEC 60695-11-5; 10 s	No burning after 30 s	
4.24	78 (Cab)	Damp heat, steady state	(40 $\pm$ 2) °C; (93 $\pm$ 3) % RH; 56 days	$\pm (1 \% R + 0.05 \Omega)$	
4.25.3	-	Endurance at upper category temperature	155 °C, 1000 h	$\pm (1 \% R + 0.05 \Omega)$	$\pm (2 \% R + 0.1 \Omega)$
4.40	-	Electrostatic discharge (Human Body Model)	IEC 61340-3-1 3 pos. + 3 neg. discharges; ESD voltage: 1000 V	$\pm (1 \% R + 0.05 \Omega)$	
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol; 50 °C; method 2	No visible damage	
4.30	45 (XA)	Solvent resistance of marking	Isopropyl alcohol; 50 °C; method 1, toothbrush	Marking legible, no visible damage	
4.22	6 (Fc)	Vibration, endurance by sweeping	f = 10 Hz to 2000 Hz; x, y, z ≤ 1.5 mm; A ≤ 200 m/s ² ; 10 sweeps per axis	$\pm (0.25 \% R + 0.05 \Omega)$	$\pm (0.5 \% R + 0.05 \Omega)$
4.37	-	Periodic electric overload	$U = \sqrt{15 \times P_{70} \times R}$ $\leq 2 \times U_{\max.}$; 0.1 s on; 2.5 s off; 1000 cycles	$\pm (1 \% R + 0.05 \Omega)$	
4.27	-	Single pulse high voltage overload, 10 μ s/700 μ s	$\hat{U} = 10 \times \sqrt{P_{70} \times R}$ $\leq 2 \times U_{\max.}$; 10 pulses	$\pm (1 \% R + 0.05 \Omega)$	

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 140400, sectional specification
- EN 140401-802, detail specification
- IEC 60068-2-x environmental test procedures

Packaging of components is done in paper or blister tapes according to IEC 60286-3



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.